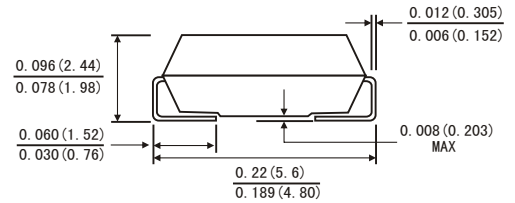
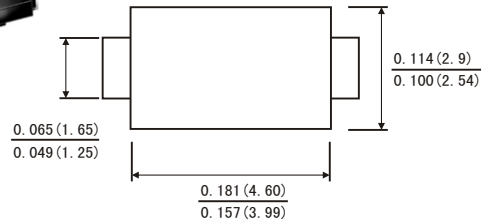


FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Construction utilizes void-free molded plastic technique
- For surface mounted applications
- Built-in strain relief, ideal for automated placement
- High temperature soldering guaranteed: 260 °C/10 seconds at terminals
- Component in accordance to RoHs 2002/95/EC and WEEE 2002/96/EC



SMA(DO-214AC)



Dimensions in inches and (millimeters)

MECHANICAL DATA

- Case: JEDEC DO-214AC molded plastic over glass passivated chip
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Weight: 0.002 oz., 0.064 g

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Ratings at 25°C ambient temperature unless otherwise specified ,Single phase ,half wave 60Hz.,resistive or inductive load. For capacitive load, derate by 20%.)

		Symbols	S1A	S1B	S1D	S1G	S1J	S1K	S1M	Units
Maximum Recurrent Peak Reverse Voltage		V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage		V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage		V_{DC}	50	100	200	400	600	800	1000	Volts
Maximum average Forward Rectified Current 0.375"(9.5mm) lead length at $T_A=75^\circ\text{C}$		$I_{(AV)}$	1.0							Amp
Peak Forward Surge Current (8.3ms half sine-wave superimposed on rated load (JEDEC method) $T_A=75^\circ\text{C}$		I_{FSM}	30.0							Amps
Maximum Instantaneous Forward Voltage at 1.0 A		V_F	1.1							Volts
Maximum Reverse current at rated DC Blocking Voltage	$T_A=25^\circ\text{C}$	I_R	5.0							μA
	$T_A=125^\circ\text{C}$		50.0							
Typical Thermal resistance (Note 2)		$R_{\theta JL}$	30							$^\circ\text{C/W}$
Typical Junction Capacitance(Note 1)		C_J	15							pF
		T_J T_{STG}	-65 to+175							$^\circ\text{C}$

Note: 1.Measured at 1MHz and applied reverse voltage of 4.0V DC.

2.Thermal resistance from junction to ambient and from junction to lead at 0.375"(9.5mm)lead length, P.C.B. mounted

FIG.1-FORWARD CURRENT DERATING CURVE

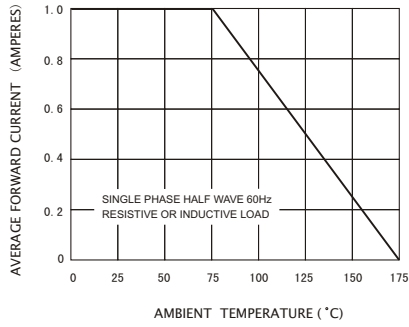


FIG.2-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

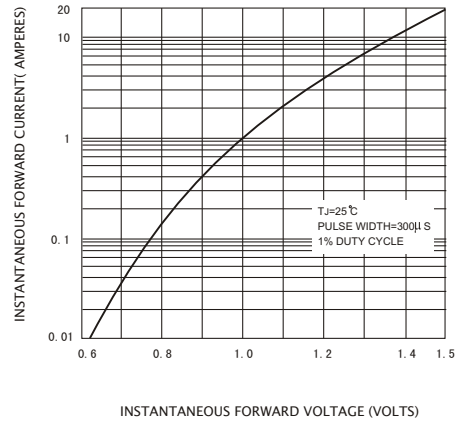


FIG.3-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

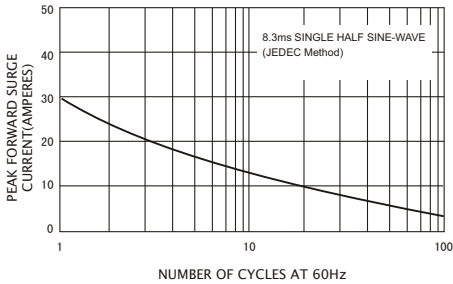


FIG.4-TYPICAL REVERSE CHARACTERISTICS

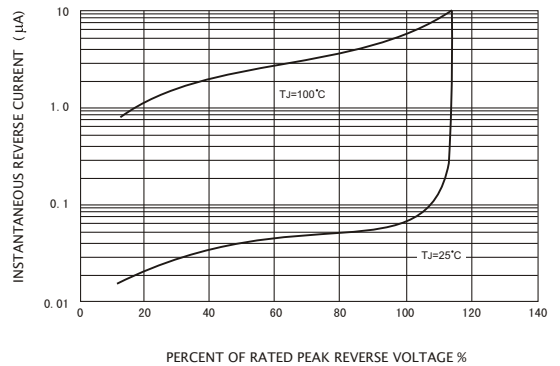


FIG.5-TYPICAL JUNCTION CAPACITANCE

